

## News and Updates

### **SPiCE 1-2-1 for Automotive PAM 3.1 Update: now inc. HWE 1.0 - Hardware Engineering**

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#### **V3.3.14 available now!**

### **Assessment Software Update V3.3.14**

#### **New: Hardware Engineering PAM 1.0**

Starting with Software Version 3.3.14 you have four additional processes defined by a new PAM proposed by intacs. The processes follow the plug-in concept defined by Automotive SPiCE. So now you can perform SPiCE assessments which also cover the mechanics AND the hardware aspects of systems development. The HWE PAM (and also the MEC PAM) is available in English and German.



The AutomotiveSPiCE PAM 3.1 released on Nov. 1<sup>st</sup> 2017, the PAM for Mechanical Engineering MEC 1.5 from Dec. 6<sup>th</sup> 2018, and the PAM for Hardware Engineering HWE 1.0 from Nov. 15<sup>th</sup> 2019 is available with Software Version 3.3.14 of the Assessment Tool SPiCE 1-2-1 for Automotive.

Additionally it still contains the PAM 3.0, released on July, 16<sup>th</sup> 2015.

Beyond the usual assessment features, the assessor can switch between English and German during the assessment.

Because of structural changes in the process dimension and amongst the generic practices - inspired from ISO 33020 - the assessment files with PAM 3.1 are not compatible with PAM 2.5 (oder 2.4, 2.3) files.

Therefore we offer two separate tools: one for PAM 3.1/3.0, the other for PAM 2.5.